

CRYSTAL OSCILLATOR (SPXO)

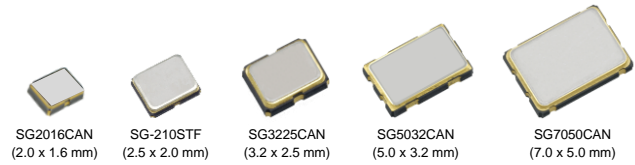
OUTPUT : CMOS



Product Number (please contact us)  
 SG2016CAN: X1G004801xxxx00  
 SG-210STF: X1G004171xxxx00  
 SG3225CAN: X1G005961xxxx15  
 SG5032CAN: X1G004451xxxx00  
 SG7050CAN: X1G004481xxxx00

SG2016 / 3225 / 5032 / 7050CAN  
 SG-210STF

- Frequency : 20 standard frequencies
- Supply voltage : 1.8 V to 3.3 V Typ.
- Function : Standby( $\overline{ST}$ )
- Operating temperature : -40 °C to +105 °C



Specifications (characteristics)

Item	Symbol	Specifications	Conditions / Remarks		
Output frequency	$f_o$	4 MHz 8 MHz 10 MHz 12 MHz 12.288 MHz 14.7456 MHz 16 MHz 20 MHz 24 MHz 24.576 MHz 25 MHz 26 MHz 27 MHz 32 MHz 33.33 MHz 33.3333 MHz 40 MHz 48 MHz 50 MHz 72 MHz			
Supply voltage	$V_{CC}$	1.60 V to 3.63 V 1.71 V to 3.63 V 2.25 V to 3.63 V	4 MHz $\leq f_o \leq$ 50 MHz, $T_{use} = +105$ °C Max. fo = 72 MHz, $T_{use} = +85$ °C Max. fo = 72 MHz, $T_{use} = +105$ °C Max. Refer to Figure 1		
Storage temperature	$T_{stg}$	-55 °C to +125 °C -40 °C to +125 °C	SG2016CAN All others		
Operating temperature	$T_{use}$	-20 °C to +70 °C, -40 °C to +85 °C, -40 °C to +105 °C	See of figure *1		
Frequency tolerance	$f_{tol}$	$\pm 25 \times 10^{-6}$ $\pm 50 \times 10^{-6}$	-20 °C to +70 °C -40 °C to +85 °C, -40 °C to +105 °C		
Current consumption	$I_{CC}$	$V_{CC} = 1.8 V \pm 10 \%$	$V_{CC} = 2.5 V \pm 10 \%$	$V_{CC} = 3.3 V \pm 10 \%$	
		1.5 mA Max.	1.6 mA Max.	1.8 mA Max.	No load condition, 4 MHz $\leq f_o \leq$ 20 MHz
		1.8 mA Max.	2.0 mA Max.	2.2 mA Max.	No load condition, 20 MHz < $f_o \leq$ 40 MHz
		2.1 mA Max.	2.4 mA Max.	2.6 mA Max.	No load condition, 40 MHz < $f_o \leq$ 50 MHz
2.4 mA Max.	2.8 mA Max.	3.0 mA Max.	No load condition, fo = 72 MHz		
Stand-by current	$I_{std}$	2.1 $\mu$ A Max. 2.5 $\mu$ A Max. 2.7 $\mu$ A Max.	$\overline{ST} = GND$		
Symmetry	SYM	45 % to 55 %	50 % $V_{CC}$ level, $L_{CMOS} \leq 15$ pF		
Output voltage	$V_{OH}$	90 % $V_{CC}$ Min.			
	$V_{OL}$	10 % $V_{CC}$ Max.			
	$V_{OH-2}$	$V_{CC} - 0.4$ V Min.			
	$V_{OL-2}$	0.4 V Max.			
Output load condition (CMOS)	$L_{CMOS}$	15 pF Max.			
Input voltage	$V_{IH}$	80 % $V_{CC}$ Min.	$\overline{ST}$ terminal		
	$V_{IL}$	20 % $V_{CC}$ Max.			
Rise time and Fall time	$t_r / t_f$	3 ns Max. 3.5 ns Max. (@1.8 V $\pm$ 10 %)	20 % $V_{CC}$ to 80 % $V_{CC}$ level, $L_{CMOS} = 15$ pF		
Start-up time	$t_{str}$	3 ms Max.	$T = 0$ at 90 % $V_{CC}$		
Frequency aging	$f_{age}$	$\pm 3 \times 10^{-6}$ / year Max.	+25 °C, First year		

[Model : SG2016 / 3225 / 5032 / 7050CAN]

Product name SG2016CAN25.000000MHzTJHA

(Standard form) ① ② ③ ④⑤⑥⑦

①Model ②Output(C: CMOS) ③Frequency ④Supply voltage

⑤Frequency tolerance ⑥Operating temperature range

⑦Internal identification code("A" is default)

④Supply voltage *See Figure 1	
T	1.8 V to 3.3 V Typ.
K	2.5 V to 3.3 V Typ.

⑤Frequency tolerance / ⑥Operating temperature range	
DB*	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C
JG	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C
JH	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C

\* Please refer to Product number list on Full Data Sheet for available frequencies

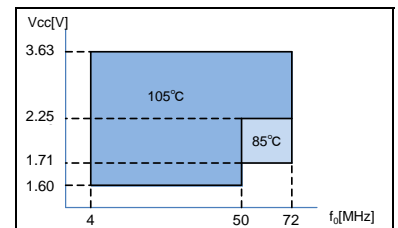


Figure 1 : The upper limit of Operating temperature and the related conditions

Please note that Supply voltage range ( $V_{CC}$ ) depends on Output frequency ( $f_o$ ) and upper limit of Operating temperature ( $T_{use}$  Max.).

[Model : SG-210STF]

Product name SG-210STF25.000000MHzY

(Standard form) ① ②③ ④ ⑤

①Model ②Function(S:Standby) ③Supply voltage

④Frequency ⑤Frequency tolerance

③Supply voltage *See Figure 1	
T	1.8 V to 3.3 V Typ.

⑤Frequency tolerance	
S*	$\pm 25 \times 10^{-6}$ / -20 °C to +70 °C
L	$\pm 50 \times 10^{-6}$ / -40 °C to +85 °C
Y	$\pm 50 \times 10^{-6}$ / -40 °C to +105 °C

\* Please refer to Product number list on Full Data Sheet for available frequencies



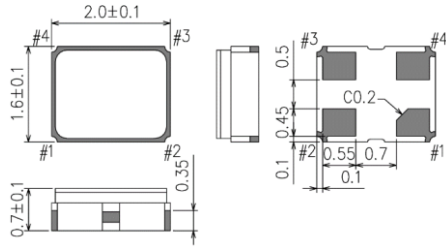
External dimensions

(Unit:mm)

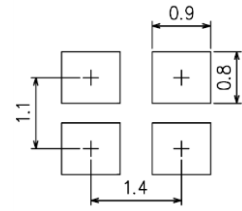
Footprint (Recommended)

(Unit:mm)

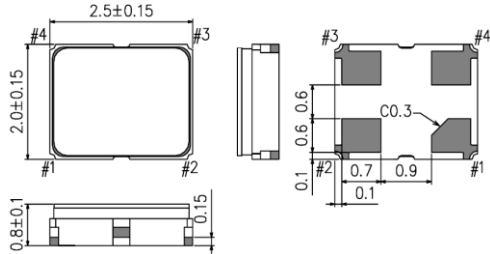
SG2016CAN



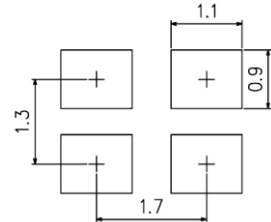
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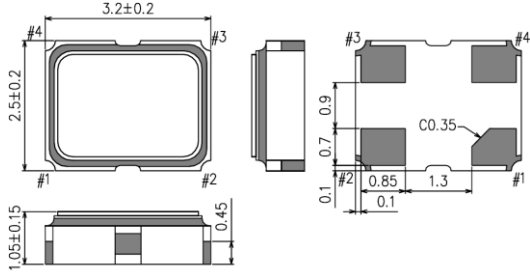
SG-210STF



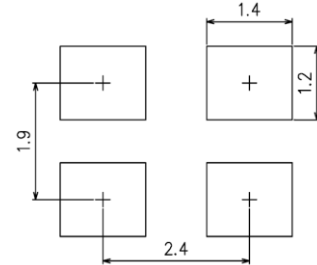
SG-210STF



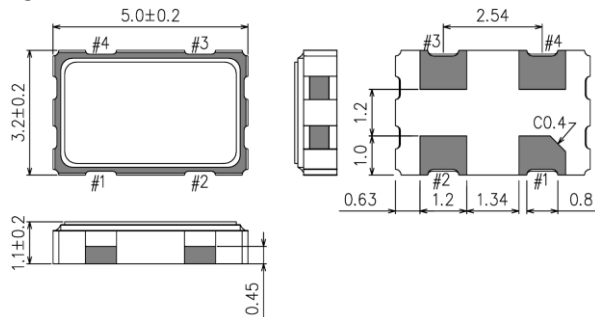
SG3225CAN



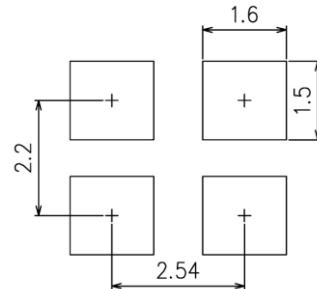
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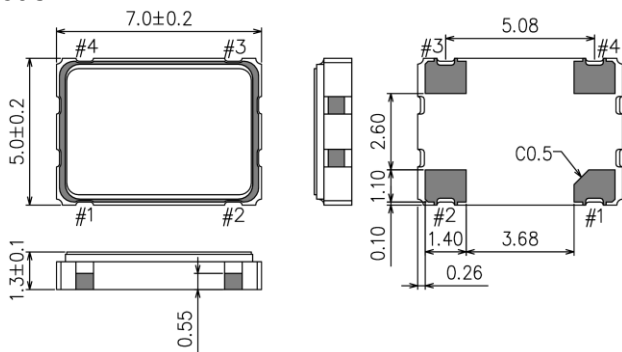
SG5032CAN



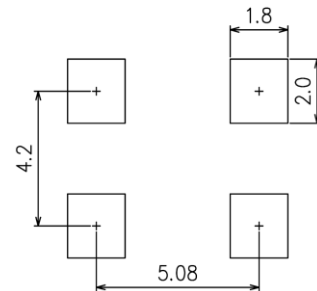
SG5032CAN



SG7050CAN



SG7050CAN



Pin Map

Pin	Connection	Function		
1	ST	ST terminal		
		ST function	Oscillator circuit	Output
		HIGH or "open"	Oscillation	Specified frequency: Enable
		LOW	Oscillation stop	High impedance: Disable
2	GND	Ground		
3	OUT	Clock output		
4	V <sub>CC</sub>	Power supply		

■Notes: To maintain stable operation, provide a 0.01uF to 0.1uF by-pass capacitor at a location as near as possible to the power source terminal of the crystal product (between V<sub>CC</sub> - GND).

## PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

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	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
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